

Surface Mount Technology (SMT) board connectors		
D-Sub – SMT		
Technical characteristics	21.02	
Standard versions	21.04	
Low-profile versions	21.06	
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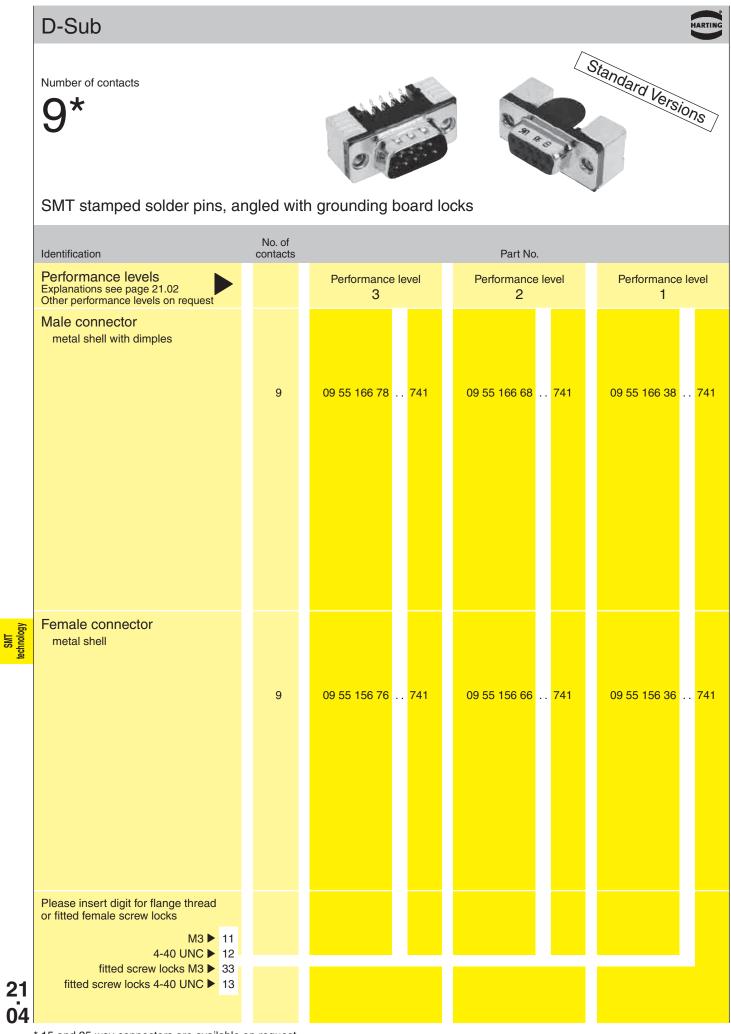
D-Sub SMT solder version

Number of contacts	9, 15*, 25*	Contact arrangement View from termination side
Working current	5 A	9 way M F 15 way* M F
Test voltage U _{r.m.s.}	1 kV	25 way* M = Male connector F = Female connector
Clearance and creepage	≥ 1.0 mm	Mating conditions as per DIN 41 652
Contact resistance Insulation resistance	< 25 mΩ < 5 GΩ	
Temperature range	as per profile JEDEC 020 D	
Terminations	Solder pins for P.C.B. pads	
Materials		
Mouldings	LCP black UL 94-V0	
Contacts	Phosphorus bronze	
Grounding die	Zamac	
Shell	Steel	
Contact surface Contact zone	selectively gold-plated according to performance level ¹⁾	
Grounding die	Pure tin	
Shell	Nickel plated	
Insertion and withdrawal forc – insertion max. per connector: – withdrawal min. per connector:	30 N	

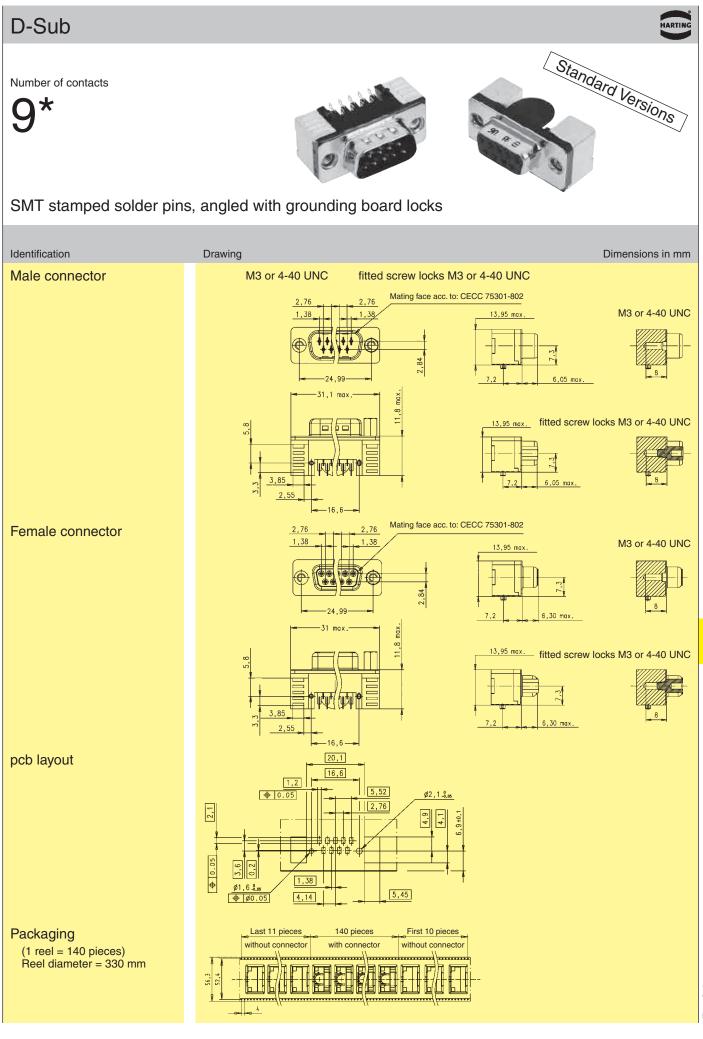
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 ¹⁾ Performance level 3, 50 mating cycles, no gas test Performance level 2 as per CECC 75 301-802, 250 mating cycles, 4 days 4 mixed gas test – IEC 60 512 Performance level 1 as per CECC 75 301-802, 500 mating cycles, 10 days 4 mixed gas test – IEC 60 512
* Available on request

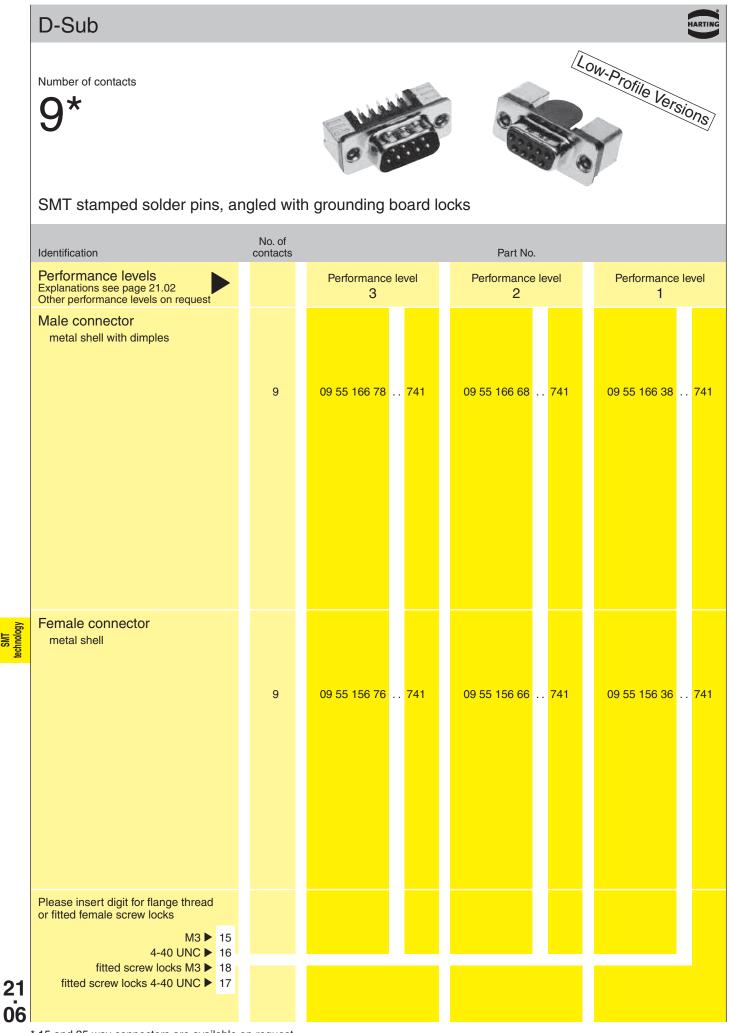
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* 15 and 25 way connectors are available on request Connector dimensions see page 21.05. Mating conditions see page 21.02.

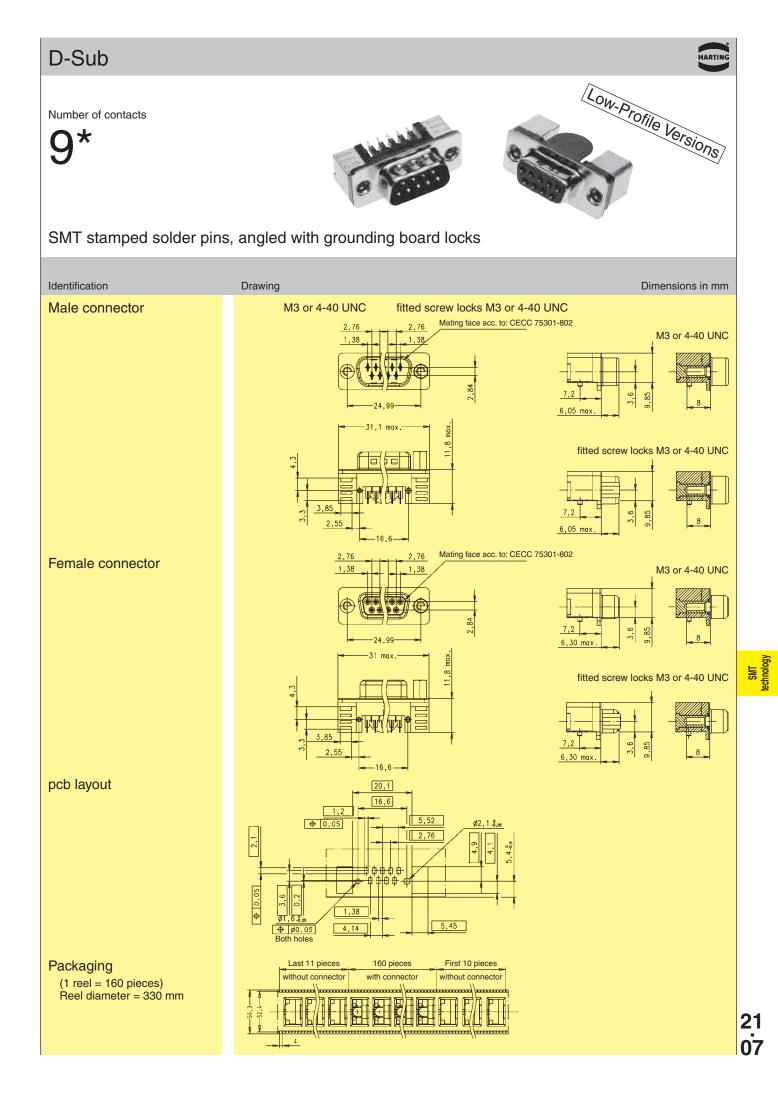


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* 15 and 25 way connectors are available on request Connector dimensions see page 21.07. Mating conditions see page 21.02.

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